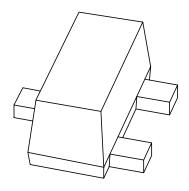
DISCRETE SEMICONDUCTORS

DATA SHEET



1PS89SB14; 1PS89SB15; 1PS89SB16

Schottky barrier double diodes

Product specification Supersedes data of 1998 Nov 10 2003 Apr 28





Schottky barrier double diodes

1PS89SB14; 1PS89SB15; 1PS89SB16

Product specification

FEATURES

- Power dissipation comparable to SOT23
- Low forward voltage
- · Guard ring protected
- Ultra small SMD package.

APPLICATIONS

- Ultra high speed switching
- · Voltage clamping
- · Protection circuits
- Blocking diodes.

DESCRIPTION

Planar Schottky barrier double diodes encapsulated in an ultra small plastic SMD SC-89 (SOT490) package.

MARKING

TYPE NUMBER	MARKING CODE
1PS89SB14	44
1PS89SB15	43
1PS89SB16	45

PINNING

PIN	1PS89SBxx		
FIIN	14	15	16
1	a ₁	a ₁	k ₁
2	k ₂	a ₂	k ₂
3	k ₁ , a ₂	k ₁ , k ₂	a ₁ , a ₂

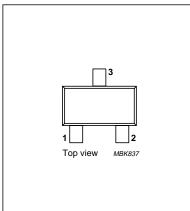


Fig.1 Simplified outline (SC-89; SOT490) and pin configuration.

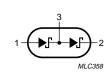


Fig.2 1PS89SB14 diode configuration (symbol).

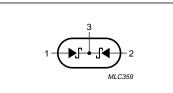


Fig.3 1PS89SB15 diode configuration (symbol).

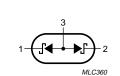


Fig.4 1PS89SB16 diode configuration (symbol).

Philips Semiconductors Product specification

Schottky barrier double diodes

1PS89SB14; 1PS89SB15; 1PS89SB16

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
Per diode	Per diode unless otherwise specified					
V _R	continuous reverse voltage		_	30	V	
IF	continuous forward current		_	200	mA	
I _{FRM}	repetitive peak forward current	$t_p \le 1 \text{ s}; \ \delta \le 0.5$	_	300	mA	
I _{FSM}	non-repetitive peak forward current	t _p < 10 ms	_	600	mA	
P _{tot}	total power dissipation (per package)	T _{amb} ≤ 25 °C	_	200	mW	
T _{stg}	storage temperature		-65	+150	°C	
Tj	junction temperature		_	125	°C	
T _{amb}	operating ambient temperature		-65	+125	°C	

ELECTRICAL CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
Per diode unless otherwise specified				
V _F	forward voltage	see Fig.5		
		I _F = 0.1 mA	240	mV
		I _F = 1 mA	320	mV
		I _F = 10 mA	400	mV
		I _F = 30 mA	500	mV
		I _F = 100 mA	800	mV
I _R	reverse current	V _R = 25 V; note 1; see Fig.6	2	μΑ
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; see Fig.7	10	pF

Note

1. Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	500	K/W

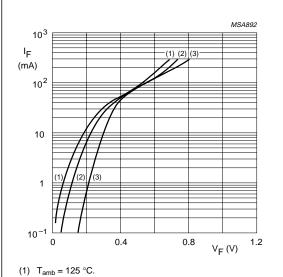
Note

1. Refer to SC-89 (SOT490) standard mounting conditions.

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GRAPHICAL DATA



- (2) $T_{amb} = 85 \,^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.

Fig.5 Forward current as a function of forward voltage; typical values.

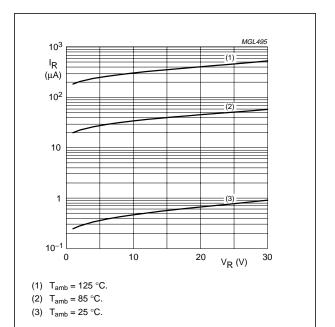
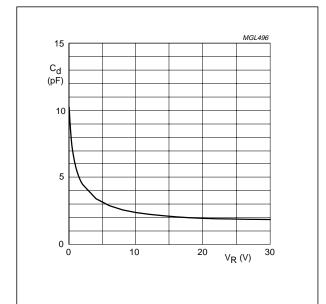


Fig.6 Reverse current as a function of reverse voltage; typical values.



 $f = 1 \text{ MHz}; T_{amb} = 25 \, ^{\circ}\text{C}.$

Diode capacitance as a function of reverse voltage; typical values.

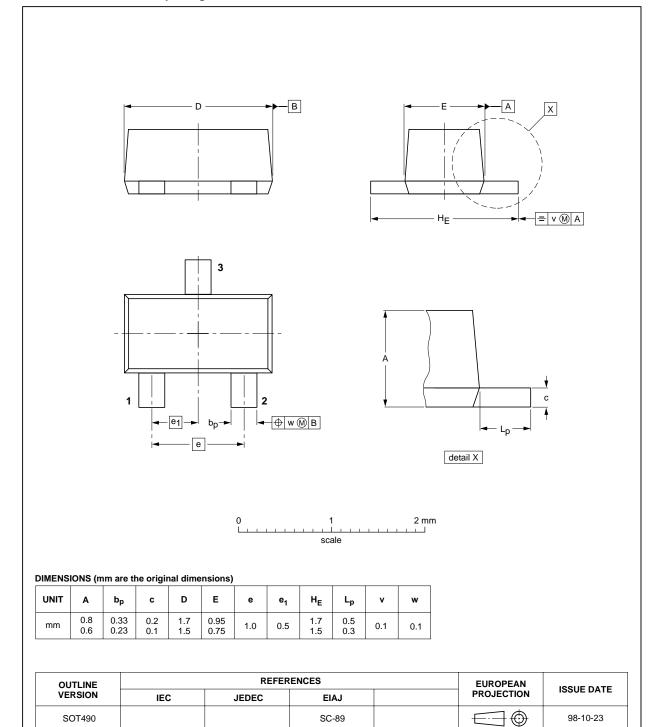
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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT490



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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
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Philips Semiconductors Product specification

Schottky barrier double diodes

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NOTES

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